SPECIFICATION FOR LCD MODULE

Model No. TM640480ACCWT

Prepared by: Date: Checked by: Date: Verified by: Date: Approved by: Date:

TIANMA MICROELECTRONICS CO., LTD

REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Item
2003-8-7	1.0			

1. General Specifications:

1.1 Display type: FSTN (dual mode)

1.2 Display color*:

Display color: Black
Background: White

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/240 Duty 1/13 Bias

1.6 LCD operating voltage: 23.3V

1.7 VDD: 3.3V

1.8 Backlight: LED (White)

1.9 Driver: S6B0794X01-07 (X11)

1.10 Data Transfer: 4 Bit Parallel

1.11 Operating Temperature: -20----+70 °C

Storage Temperature: -30----+80 ℃

1.12 Outline Dimensions: Refer to outline drawing on next page

 1.13 Dot Matrix:
 640 X 480 Dots

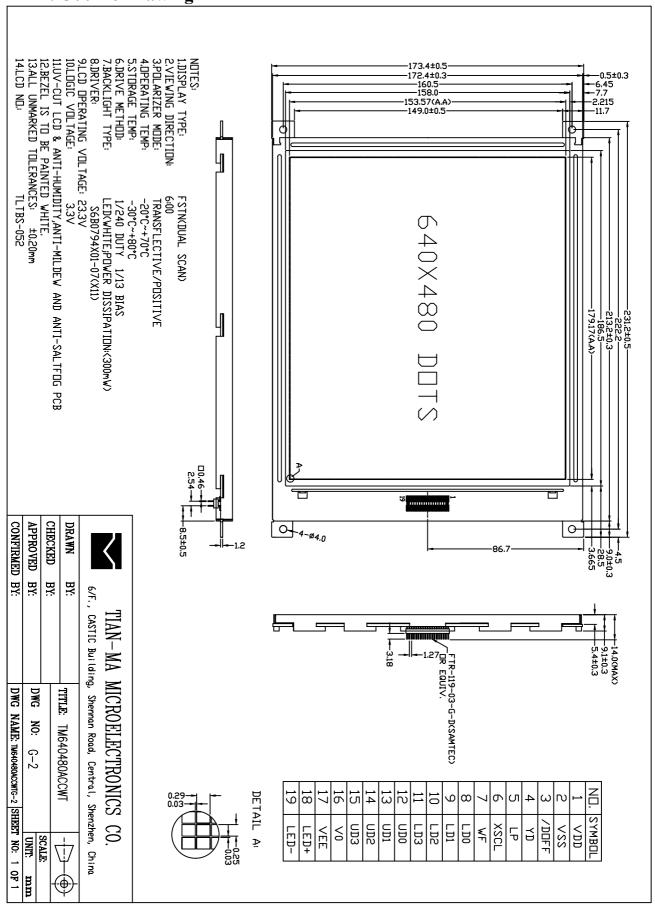
 1.14 Dot Size:
 0.25X0.29 (mm)

 1.15 Dot Pitch:
 0.28X0.32 (mm)

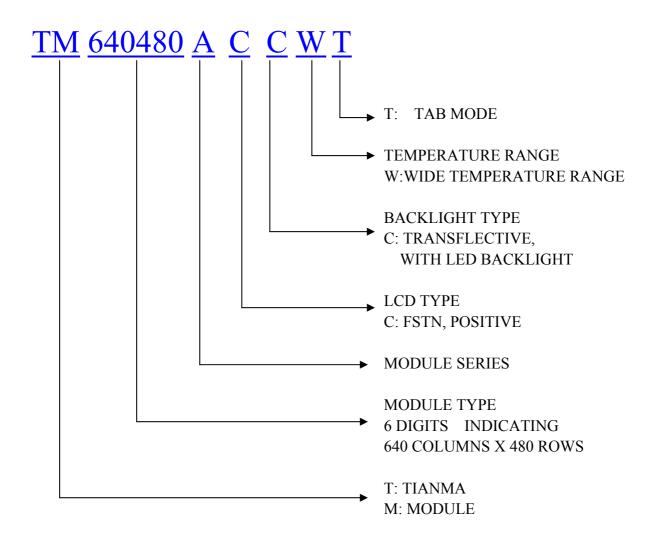
 1.16 Weight:
 Approx 1200g

^{*} Color tone is slightly changed by temperature and driving voltage.

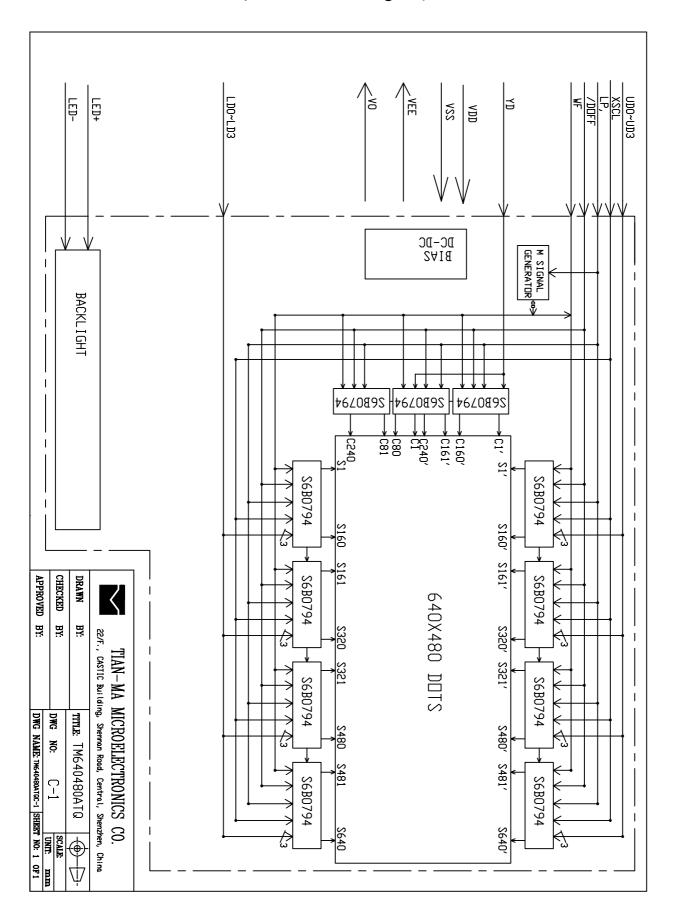
2. Outline Drawing



3. LCD Module Part Numbering System



4. Electronic Character (Circuit Block Diagram)



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	V _{DD} -V _{SS}	-0.3	6.0	V	
LCD Driving Voltage	V _{LCD}	-	28.0	V	
Operating Temperature Range	Тор	-20	+70	°C	No
Storage Temperature Range	Тѕт	-30	+80		Condensation

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Iten	n	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage (Logic)		V _{DD} -V _{SS}	1	3.3	5.5	V
Supply Voltage (LCD Drive)		Vlcd	-	23.3	-	V
Input	High	V_{IH} $(V_{DD}=3.0)$	$0.8 \mathrm{V}_\mathrm{DD}$	1	V _{DD} +0.3	V
Signal Voltage	Low	V_{IL} (V_{DD} =3.0)	0	1	$0.2V_{\mathrm{DD}}$	V
Supply current (Logic)		I_{DD} $(V_{DD}-V_{SS}=3.3V)$	-	20.0	30.0	mA
Supply current (LED Drive)		I _{LED} (LED+ - LED-=3.3V)	-	70	100	mA

6.2 Interface Signals

Pin No.	Symbol	Level	Description
1	VDD	3.3V	Power Supply For LOGIC
2	VSS	0V	GROUND
3	/DOFF	H/L	H: Display On L: Display Off
4	YD	H/L	COM data signal
5	LP	H/L	Latch Pulse of Display Data
6	XSCL	H/L	Clock Pules for Segment Shift Register
7	WF	H/L	Switch Signal to Convert LCD Driver
8	LD0	H/L	Input Data bit for lower screen
9	LD1	H/L	
10	LD2	H/L	
11	LD3	H/L	
12	UD0	H/L	Input Data bit for upper screen
13	UD1	H/L	
14	UD2	H/L	
15	UD3	H/L	
16	V0	23.3V	LCD operating voltage; output
17	VEE	-	Built-in DC~DC CONVERTOR OUTPUT
18	LED+	3.3V	LED BACKLIGHT POWER SUPPLY
19	LED-	0V	

6.3 Interface Timing Chart

AC CHARACTERISTICS

SEGMENT MODE AC CHARACTERISTICS

Segment Mode 1

(Vss=V5=0V, VDD=+4.5 to +5.5V, V0=+15 to +32V, $Ta=-20-85^{\circ}C$)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Shift clock period *1	Twck	TR, TF≤10 ns	71			ns
Shift clock "H" pulse width	Twckh		23			ns
Shift clock "L" pulse width	TWCKL		23			ns
Data setup time	Tos		10			ns
Data hold time	Трн		20			ns
Latch pulse "H" pulse width	TWLPH		23			ns
Shift clock rise to latch pulse rise time	TLD		0			ns
Shift clock fall to latch pulse fall time	TsL		25			ns
Latch pulse rise to shift clock rise time	TLS		25			ns
Latch pulse fall to shift clock fall time	TLH		25			ns
Input signal rise time *2	Tr				50	ns
Input signal fall time *2	TF				50	ns
Enable setup time	Ts		21			ns
DISPOFFB removal time	Tsd		100			ns
DISPOFFB "L" pulse width	TWDL		1.2			us
Output delay time (1)	TD	CL=15pF			40	ns
Output delay time (2)	TPD1, TPD2	CL=15pF			1.2	us
Output delay time (3)	TPD3	CL=15pF			1.2	us

Note: *1 Take the cascade connection into consideration.

 $^{^{*}2}$ (TWCK – TWCKH – TWCKL) / 2 is maximum in the case of high speed operation.

Segment Mode 2

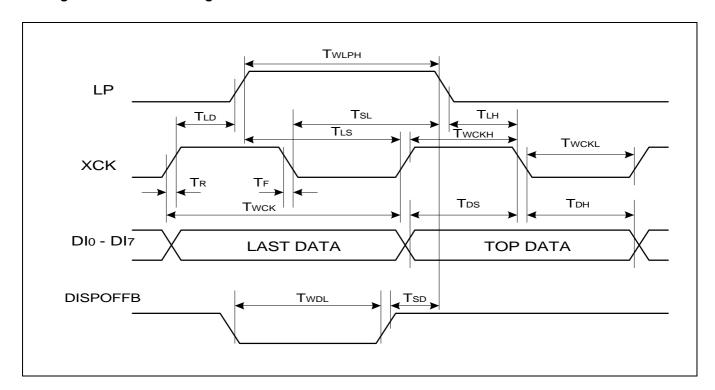
(VSS=V5=0V, VDD=+2.4V to +4.5V, V0=+15 to +32V, Ta=-20~85 $^{\circ}$ C)

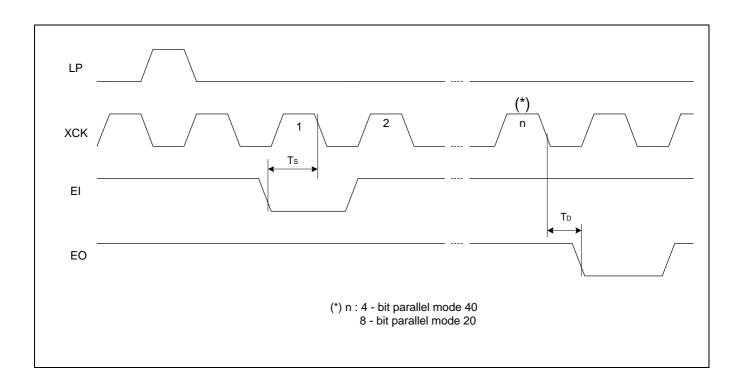
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Shift clock period *1	Twck	TR, TF≤10 ns	125			ns
Shift clock "H" pulse width	Twckh		51			ns
Shift clock "L" pulse width	TWCKL		51			ns
Data setup time	Tos		30			ns
Data hold time	Трн		40			ns
Latch pulse "H" pulse width	TWLPH		51			ns
Shift clock rise to latch pulse rise time	TLD		0			ns
Shift clock fall to latch pulse fall time	TsL		51			ns
Latch pulse rise to shift clock rise time	TLS		51			ns
Latch pulse fall to shift clock fall time	TLH		51			ns
Input signal rise time *2	Tr				50	ns
Input signal fall time *2	TF				50	ns
Enable setup time	Ts		36			ns
DISPOFFB removal time	Tsd		100			ns
DISPOFFB "L" pulse width	TWDL		1.2			us
Output delay time (1)	TD	CL=15pF			78	ns
Output delay time (2)	TPD1, TPD2	CL=15pF			1.2	us
Output delay time (3)	TPD3	CL=15pF			1.2	us

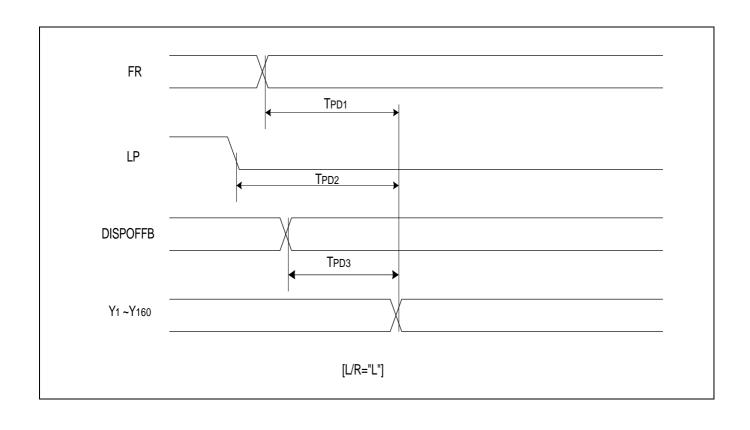
Note: *1 Take the cascade connection into consideration.

^{*2 (}TWCK – TWCKH – TWCKL) / 2 is maximum in the case of high speed operation.

Timing Characteristics of Segment Mode







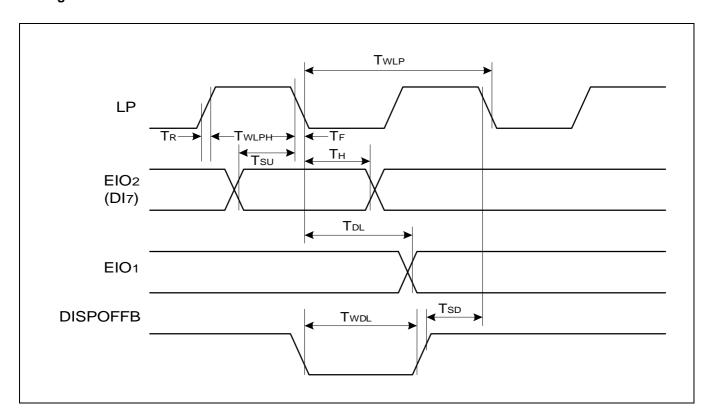
COMMON MODE AC CHARACTERISTICS

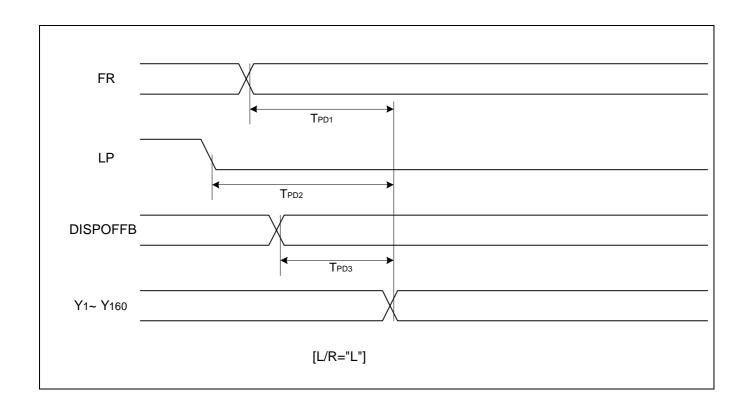
Common Mode

(Vss=V5=0V, Vdd=+2.4V to +4.5V, V0=+15 to +32V, Ta=-20~85°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Shift clock period	TWLP	Tr, Tr≤20ns	250			ns
Chift "H" pulse width	Twinnin	VDD=+5.0V±10%	15			ns
Shift "H" pulse width	TWLPH	VDD=+2.5V~+4.5V	30			ns
Data setup time	Tsu		30			ns
Data hold time	Тн		50			ns
Input signal rise time	Tr				50	ns
Input signal fall time	TF				50	ns
DISPOFFB removal time	Tsd		100			ns
DISPOFFB 'L" pulse width	TWDL		1.2			us
Output delay time (1)	TDL	CL=15pF			200	ns
Output delay time (2)	TPD1,TPD2	CL=15pF			1.2	us
Output delay time (3)	TPD3	CL=15pF			1.2	us

Timing Characteristics of Common Mode





7. Optical Characteristics

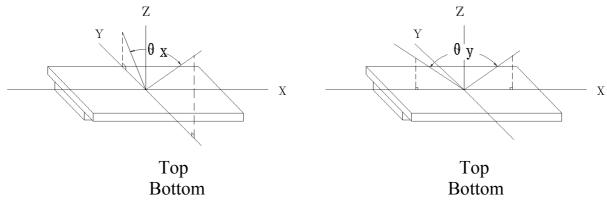
7.1 Optical Characteristics

Ta=25℃

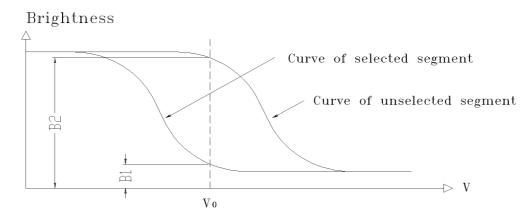
TW Ze e								
Item		Symbol	Condition		Min.	Тур.	Max.	Unit
Viewing	Anala	$\theta_{\mathbf{x}}$	C > 2	θ _y =0°	-30)	30	Dag
Viewing A	Angie	θу	Cr≥2	θ _x =0°	-30)	20	Deg
Contrast 1	Ratio	Cr	$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		3.0	-	-	
Response	Turn on	Ton	$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		-	-	350	mg
Time	Turn off	Toff	θ _y =	=0°	-	-	350	ms

7.2 Definition of Optical Characteristics

7.2.1 Definition of Viewing Angle



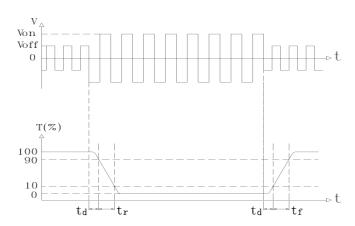
7.2.2 Definition of Contrast Ratio



Contrast Ratio = $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$

Measuring Conditions:

1) Ambient Temperature: 25 °C; 2) Frame frequency: 70Hz 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$ Turn off time: $t_{off} = t_d + t_f$

Measuring Condition:

1) Operating Voltage: 23.3V; 2) Frame frequency: 70Hz

8. Reliability

8.1 Content of Reliability Test

Ta:	=25	$^{\circ}$
I a		\sim

No.	Test Item	Content of Test	Test condition			
1	High Temperature	Endurance test applying the high	80°C 240H			
	Storage	storage temperature for a long time	Restore 4H at 25°C			
2	Low Temperature	Endurance test applying the low	-30°C 240H			
	Storage	storage temperature for a long time	Restore 4H at 25℃			
	High Temperature	Endurance test applying the high	60℃ 90%RH			
3	/Humidity Storage	temperature and high humidity	240H			
	/Trummanty Storage	storage for a long time	Restore 4H at 25°C			
		Endurance test applying the low				
		and high temperature cycle	-30°C/80°C			
4	Temperature Cycle	1 200 200 200				
	Cycle	SOTIMI SITMI SOTIMI SITMI ← — — →				
		1 cycle	Restore 4H at 25°C			
	Vibration Test	Endurance test applying the	10Hz~500Hz,			
5	(package state)	vibration during transportation	100m/s^2 ,			
	(package state)	violation during transportation	120min			
	Shock Test	Endurance test applying the shock	Half- sine wave,			
6	(package state)	during transportation	300m/s^2 ,			
	(1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-		18ms			
	Atmospheric	Endurance test applying the	25kPa 16H			
7	Pressure Test	atmospheric pressure during transportation by air	Restore 2H			
		Tansportation by all				

8.2 Failure Judgment Criterion

Criterion		Τ	est I	tem	No.			Egilyra Judgamant Critarian
Item	1	2	3	4	5	6	7	Failure Judgement Criterion
Basic Specification	√	√	√	1	√	√	1	Out of the basic Specification
Electrical Specification	√	1	1					Out of the electrical specification
Mechanical Specification					√	V		Out of the mechanical specification
Optical Characteristic	V	1	1	1			1	Out of the optical specification
Note	For test item refer to 8.1							
Remark	mark Basic specification = Optical specification + Mechanica specification							

9. QUALITY LEVEL

Examination	At T _a =25°C			Inspection	on	
or Test	(unless otherwise stated)	Min. Max. Unit		IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See Ap	opendix A	A	II	Major 1.0 Minor 2.5
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See Ap	opendix I	3	II	Major 1.0 Minor 2.5

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0^{\circ}\text{C} \sim 40^{\circ}\text{C}$

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix AInspection items and criteria for appearance defects

Items	Contents	Criteria				
Leakage		Not permitted				
Rainbow		According to the limit specimen				
Polarizer	Wrong polarizer attachment	Not permitted				
	Bubble between	Not counted		Max. 3 defects allowed		
	polarizer and glass	φ<0.3mm		0.3mm≤¢≤0.5mm		
	Scratches of polarizer	According to the limit specimen				
Black spot (in viewing area)		Not counted	Max. 3 spots allowed		Max. 3	
		X<0.2mm	0.2mm≤X≤0.5mm			
		X=(a+b)/2			spots (lines)	
Black line (in viewing area)	t b	Not counted	Max. 3 lines allowed		allowed	
		a<0.02mm	0.021	0.02mm≤a≤0.05mm b≤2.0mm		
Progressive cracks		Not permitted				

Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents	Criteria					
	Cracks on pads	a	b		c	Max. 2	
		≤3mm	≤W	V/5	≪T/2	cracks allowed	
	b ->/-	≤2mm	≤W	1/5	T/2 <c<t< td=""></c<t<>		
	Cracks on contact side	a			b		
		≤3mm ≤T/2		≤T/2			
		≤2m	m	7	Γ/2 <b<t< td=""><td colspan="2"></td></b<t<>		
Glass Cracks		C shall be not reach the seal area			Max. 2 cracks	Max. 5 cracks allowed	
	Cracks on non-contact side	a			b	allowed	
		≤3m	m		≪T/2		
		≤2mm		7	Γ/2 <b<t< td=""><td></td><td></td></b<t<>		
	- SW -	C≤0.5mm					
		d≤SW/3					
	Corner cracks	e<2.0mm ²			Max. 3 cracks allowed		
	f-r	f<2.0mm ²					
	Double side glue	Not serious crimped					
Others	Pin of TCP IC	Full tinning					
	Protective glue on IC chip	No seeing the IC chip if scratched					

Appendix BInspection items and criteria for display defects

Items		Contents	Criteria			
Open segment or open common		Not permitted				
Short		Not permitted				
Wrong viewing angle		Not permitted				
Contrast radio uneven		According to the limit specimen				
Crosstalk			According to the limit specimen			
Pin holes and cracks in segment (DOT)		Not counted	Max.3 dots allowed			
		X<0.1mm	0.1mm≤X≤0.2mm			
		X=(a+b)/2		Max.3 dots		
		Not counted	Max.2 dots allowed	allowed		
		A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm			
Black spot (in viewing area)		Not counted	Max.3 spots allowed			
		X<0.1mm	0.1mm≤X≤0.2mm			
		X=(a+b)/2	Max.3 spots (lines)			
Black line (in viewing area)	t b	Not counted	Max.3 lines allowed	allowed		
		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm			

Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Criteria			
Transfor- mation of segment		Not counted	Max. 2 defects allowed		
		x<0.1mm	0.1mm≤x≤0.2mm		
		x=(a+b)/2			
				Max.3 defects	
	D++-a	Not counted	Max. 1 defects allowed	allowed	
		a<0.1mm	0.1mm≤a≤0.2mm D>0		
	-w -a	Max.2 defects 0.8W≤a≤1.2 a=measured va W=nominal va			